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Defense Electronics Supply Center
Dayton, Ohio

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SIZE: A

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REV

MILITARY DRAWING

This drawing is available for use by all Departments and Agencies of the Department of Defense

TITLE: MICROCIRCUITS, PROGRAMMABLE INTERVAL TIMER, MONOLITHIC SILICON

DWG NO. 5962-87520

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5962-E243

DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

DESC FORM 193
MAY 86

1. SCOPE

1.1 Scope. This drawing describes device requirements for class B microcircuits in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices."

1.2 Part number. The complete part number shall be as shown in the following example:

5962-87520	01	J	X
Drawing number	Device type (1.2.1)	Case outline (1.2.2)	Lead finish per MIL-M-38510

1.2.1 Device types. The device types shall identify the circuit function as follows:

Device type	Generic number	Circuit function
01	8253	Programmable interval timer
02	8253	Programmable interval timer
03	8253-5	Programmable interval timer

1.2.2 Case outline. The case outline shall be as designated in appendix C of MIL-M-38510, and as follows:

Outline letter	Case outline
J	D-3 (24-lead, 1/2" x 1-1/4"), dual-in-line package

1.3 Absolute maximum ratings.

Supply voltage range	-0.5 V dc to +7.0 V dc
Input voltage range with respect to ground (any pin)	-0.5 V dc to +7.0 V dc
Storage temperature range	-65°C to +150°C
Maximum power dissipation (P_D)	1 W
Lead temperature (soldering, 10 seconds)	+270°C
Thermal resistance, junction-to-case (θ_{JC}):	
Case J	See MIL-M-38510, appendix C
Junction temperature (T_J)	+150°C

1.4 Recommended operation conditions.

Supply voltage (V_{CC})	5 V dc ±10% for dc testing
Supply voltage (V_{CC}):	
01 and 03 devices	5 V dc ±10% for ac testing
02 device	5 V dc ±5% for ac testing
Minimum high-level input voltage (V_{IH})	2.2 V dc
Minimum low-level input voltage (V_{IL})	-0.5 V dc
Maximum high-level input voltage (V_{IH})	V_{CC} +0.5 V dc
Maximum low-level input voltage (V_{IL})	0.7 V dc
Case operating temperature range (T_C)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 Government specifications and standards. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510 - Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Truth tables. The truth tables shall be as specified on figure 2.

3.2.3 Block diagram. The block diagram shall be as specified on figure 3.

3.2.4 Case outline. The case outline shall be in accordance with 1.2.2 herein.

3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full recommended case operating temperature range.

3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.5 herein.

TABLE I. Electrical performance characteristics.

Test	Symbol	Conditions $-55°C \le T_C \le +125°C$ unless otherwise specified	Group A subgroups	Device types	Limits		Unit
					Min	Max	
Input low voltage	V_{IL}	V_{CC} = 5 V ±10%	1, 2, 3	All		.7	V
Input high voltage	V_{IH}	V_{CC} = 5 V ±10%	1, 2, 3	All	2.2		V
Output low voltage	V_{OL}	V_{CC} = 5 V ±10% I_{OL} = 1.6 mA	1, 2, 3	All		.45	V
Output high voltage	V_{OH}	V_{CC} = 5 V ±10% I_{OH} = -150 µA	1, 2, 3	All	2.4		V
Input load current	I_{IL}	V_{CC} = 5.5 V V_{IN} = V_{CC} to 0 V	1, 2, 3	All		±20	µA
Output float leakage	I_{OFL}	V_{CC} = 5.5 V V_{OUT} = V_{CC} to 0 V	1, 2, 3	All		±20	µA
V_{CC} supply current 1/	I_{CC}	V_{CC} = 5.5 V Outputs unloaded static	1, 2, 3	All		160	mA
Input capacitance	C_{IN}	See 4.3.1d F_C = 1 MHz T_A = 25°C; V_{CC} = GND = 0 V	4	All		10	pF
Input/output capacitance	$C_{I/O}$	Unmeasured pins returned to V_{SS} T_A = 25°C; V_{CC} = GND = 0 V	4	All		20	pF
Address stable before $\overline{RD}$	t_{AR}	V_{CC} = 5 V ±10% for 01 and 03 devices V_{CC} = 5 V ±5% for 02 device See figures 4 and 5 2/	9, 10, 11	01,02	50		ns
				03	30		ns

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $-55°C \le T_C \le +125°C$ unless otherwise specified	Group A subgroups	Device types	Limits		Unit
					Min	Max	
Address hold time for $\overline{RD}$	t_{RA}	V_{CC} = 5 V ±10% for 01 and 03 devices V_{CC} = 5 V ±5% for 02 device See figures 4 and 5 2/	9, 10, 11	All	5		ns
$\overline{RD}$ pulse width 3/	t_{RR}		9, 10, 11	01,02	400		ns
				03	300		ns
Data delay from $\overline{RD}$ 4/	t_{RD}		9, 10, 11	01,02		300	ns
				03		200	ns
$\overline{RD}$ to data floating 5/	t_{DF}		9, 10, 11	01,02	25	125	ns
				03	25	100	ns
Recovery time between $\overline{RD}$ 5/ and any other control signal	t_{RV}		9, 10, 11	All	1		µs
Address stable before $\overline{WR}$	t_{AW}		9, 10, 11	01,02	50		ns
				03	30		ns
Address hold time for $\overline{WR}$	t_{WA}		9, 10, 11	All	30		ns
$\overline{WR}$ pulse width 3/	t_{WW}		9, 10, 11	01,02	400		ns
				03	300		ns

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $-55°C \le T_C \le +125°C$ unless otherwise specified	Group A subgroups	Device types	Limits		Unit
					Min	Max	
Data setup time for $\overline{WR}$	t_{DW}	V_{CC} = 5 V ±10% for 01 and 03 devices V_{CC} = 5 V ±5% for 02 device See figures 4 and 5 2/	9, 10, 11	01,02	300		ns
				03	250		ns
Data hold time for $\overline{WR}$	t_{WD}		9, 10, 11	01,02	40		ns
				03	30		ns
Recovery time between $\overline{WR}$ 5/ and any other control signal	t_{RV}		9, 10, 11	All	1		µs
Clock period	t_{CLK}		9, 10, 11	All	380	5/ DC	ns
High pulse width	t_{PWH}		9, 10, 11	All	230		ns
Low pulse width	t_{PWL}		9, 10, 11	All	150		ns
Gate width high	t_{GW}		9, 10, 11	All	150		ns
Gate width low 5/	t_{GL}		9, 10, 11	All	100		ns
Gate setup to CLK high	t_{GS}		9, 10, 11	All	100		ns
Gate hold after CLK high	t_{GH}		9, 10, 11	All	55		ns

See footnotes at end of table.

TABLE I. Electrical performance characteristics - Continued.

Test	Symbol	Conditions $-55°C \le T_C \le +125°C$ unless otherwise specified	Group A subgroups	Device types	Limits		Unit
					Min	Max	
Output delay from CLK low 4/	t_{OD}	V_{CC} = 5 V ±10% for 01 and 03 devices V_{CC} = 5 V ±5% for 02 device See figures 4 and 5 2/	9, 10, 11	All		400	ns
Output delay from gate low 4/	t_{ODG}		9, 10, 11	All		300	ns

1/ I_{CC} is measured in a static condition with no output loads applied.

2/ Test conditions: V_{IL} = 0.45 V V_{IH} = 2.4 V
V_{OL} = 0.8 V V_{OH} = 2.2 V

3/ If clock low occurs less than 100 ns after the rising edge of READ or WRITE, the counter selected during the READ or WRITE could be affected.

4/ Test condition: C_L = 100 pF.

5/ Guaranteed, if not tested.

3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.5. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

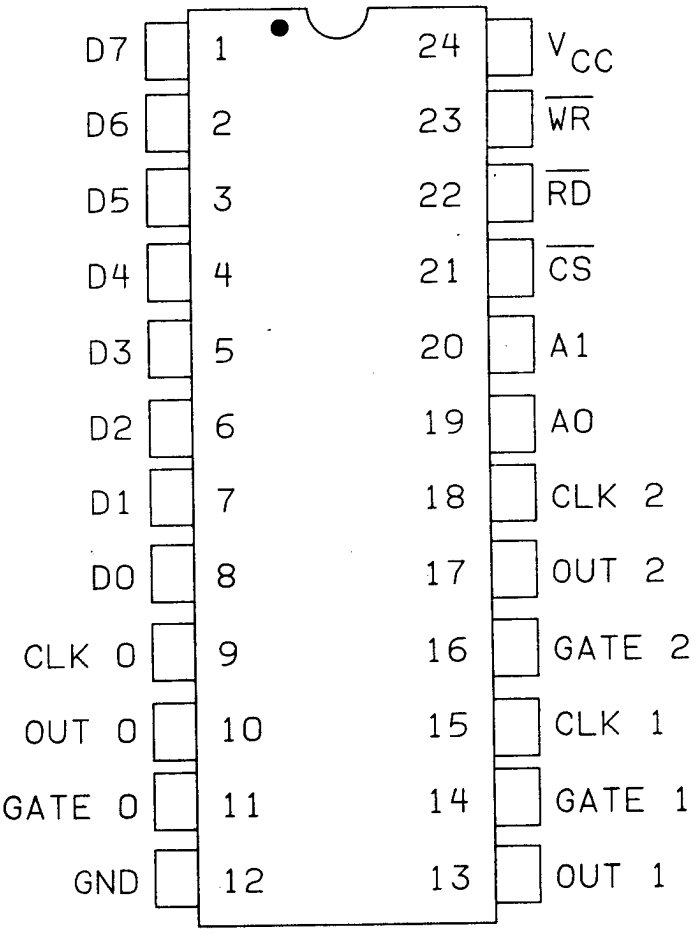
3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).

3.8 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).



Note: Pin 1 is marked for orientation

FIGURE 1. Terminal connections.

$\overline{CS}$	$\overline{RD}$	$\overline{WR}$	A1	A0	
0	1	0	0	0	Load counter no. 0
0	1	0	0	1	Load counter no. 1
0	1	0	1	0	Load counter no. 2
0	1	0	1	1	Write mode word
0	0	1	0	0	Read counter no. 0
0	0	1	0	1	Read counter no. 1
0	0	1	1	0	Read counter no. 2
0	0	1	1	1	No-operation 3-state
1	X	X	X	X	Disable 3-state
0	1	1	X	X	No-operation 3-state

Control word format

D7	D6	D5	D4	D3	D2	D1	D0
SC1	SC0	RL1	RL0	M2	M1	M0	BCD

Definition of control

SC - Select counter:

SC1	SC0	
0	0	Select counter 0
0	1	Select counter 1
1	0	Select counter 2
1	1	Illegal

RL1 RL0

0	0	Counter latching operation
1	0	Read/load most significant byte only.
0	1	Read/load least significant byte only.
1	1	Read/load least significant byte first, then most significant byte.

Mode register for latching count
A0, A1 = 11

D7	D6	D5	D4	D3	D2	D1	D0
SC1	SC0	0	0	X	X	X	X

SC1, SC0 - Specify counter to be latched.
D5, D4 - 00 designates counter latching operation.
X - Don't care

FIGURE 2. Truth tables.

Gate pin operations summary

Modes	Signal status		
	Low or going low	Rising	High
0	Disables counting	-	Enables counting
1	-	1) Initiates counting 2) Resets output after next clock	-
2	1) Disables counting 2) Sets output immediately high	1) Reloads counter 2) Initiates counting	Enables counting
3	1) Disables counting 2) Sets output immediately high	Initiates counting	Enables counting
4	Disables counting	-	Enables counting
5	-	Initiates counting	-

M- Mode:

M2	M1	M0	
0	0	0	Mode 0
0	0	1	Mode 1
X	1	0	Mode 2
X	1	1	Mode 3
1	0	0	Mode 4
1	0	1	Mode 5

BCD:

0	Binary counter 16-bits
1	Binary code decimal (BCD) counter (4 decades)

FIGURE 2. Truth tables - Continued.

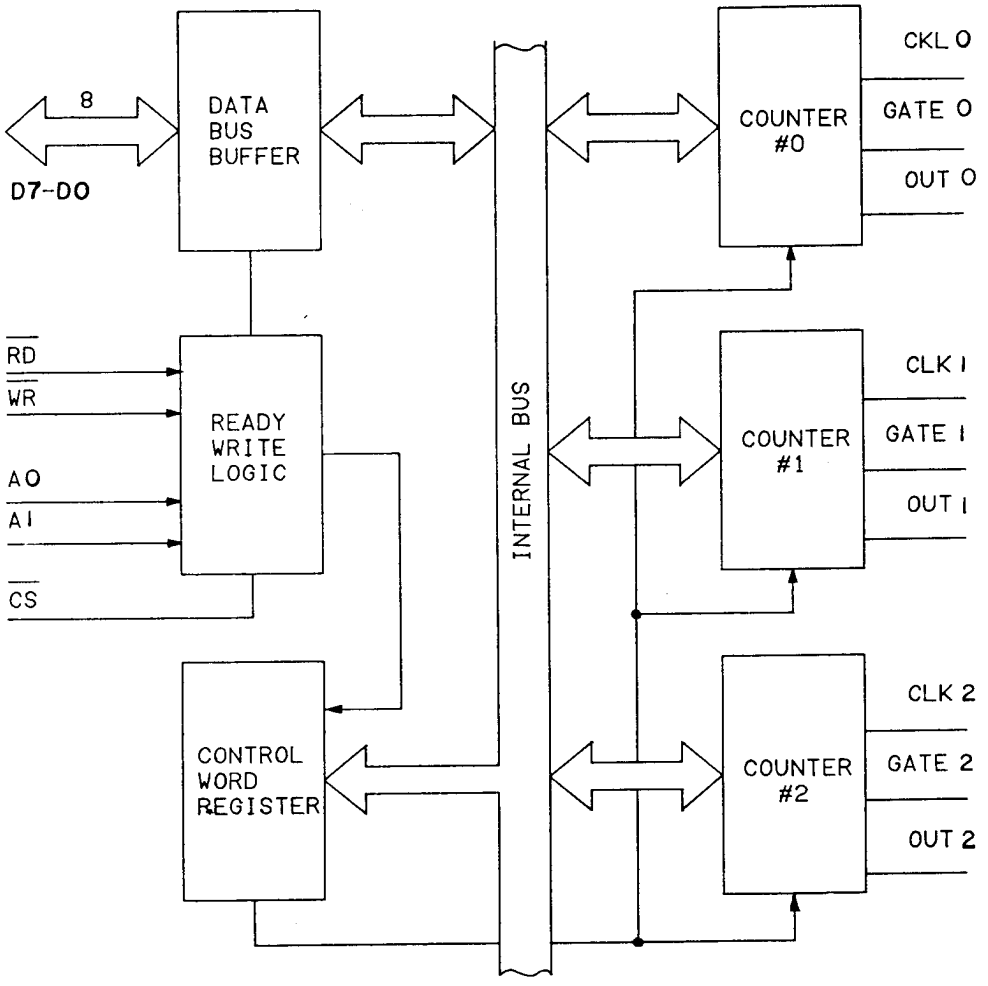


FIGURE 3. Block diagram.

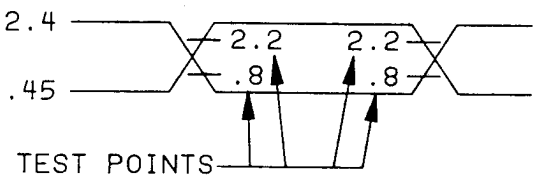


FIGURE 4. Switching test input waveform.

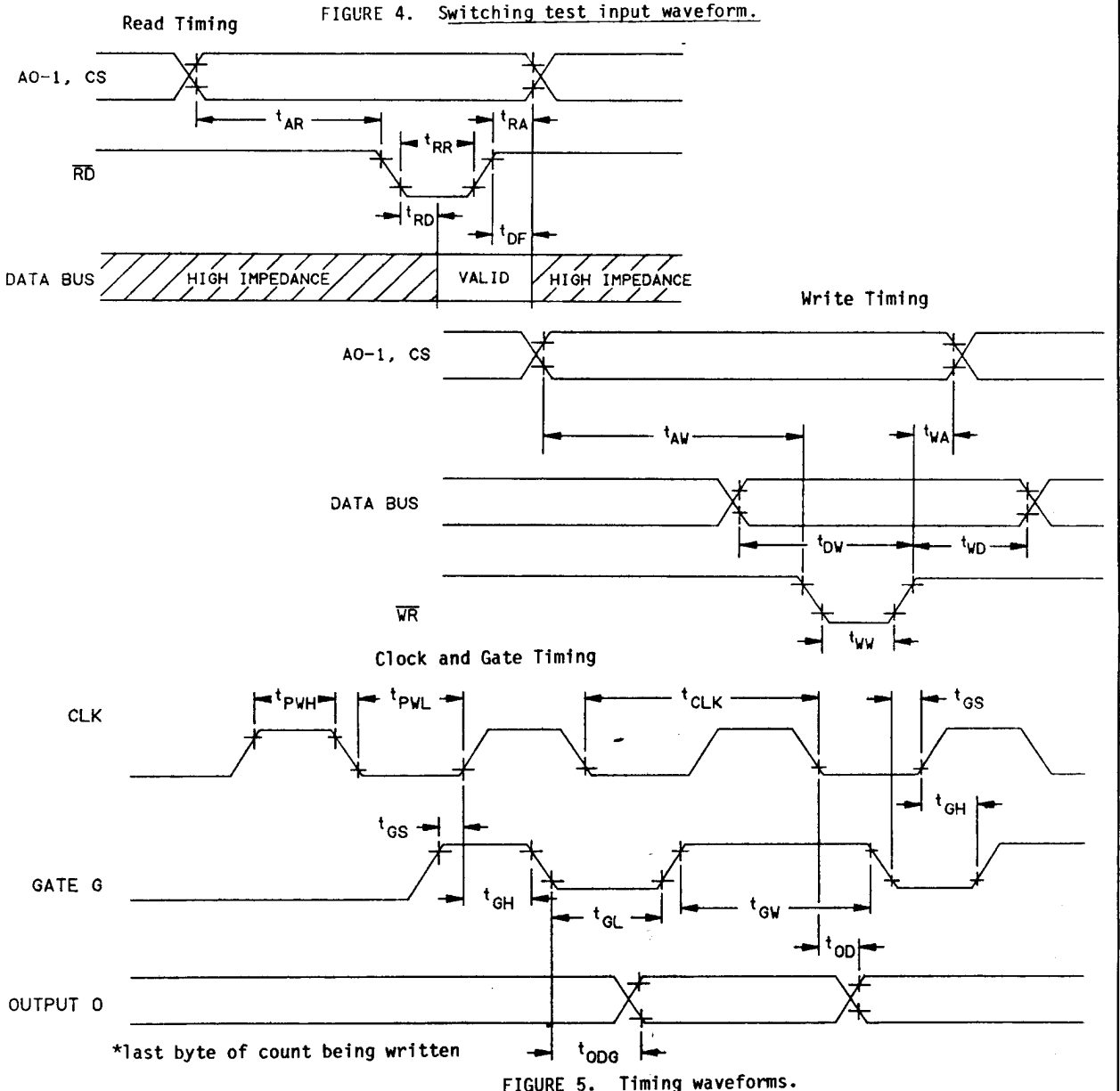


FIGURE 5. Timing waveforms.

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

a. Burn-in test (method 1015 of MIL-STD-883).

(1) Test condition D using the circuit submitted with with the certificate of compliance (see 3.5 herein).

(2) T_A = +125°C, minimum.

b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method 5005 of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

a. Tests shall be as specified in table II herein.

b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.

c. Subgroups 7 and 8 are verified by testing to the truth tables of figure 2.

d. Subgroup 4 (C_{IN} and $C_{I/O}$ measurements) shall be measured initially and after process or design changes which may affect capacitance.

4.3.2 Groups C and D inspections.

a. End-point electrical parameters shall be as specified in table II herein.

b. Steady-state life test (method 1005 of MIL-STD-883) conditions:

(1) Test condition D using the circuit submitted with the certificate of compliance (see 3.5 herein).

(2) T_A = +125°C, minimum.

(3) Test duration: 1,000 hours, except as permitted by appendix B of MIL-M-38510 and method 1005 of MIL-STD-883.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Initial electrical parameters (method 5004)	---
Final electrical test parameters (method 5004)	1*, 2, 3, 7, 8, 9, 10, and 11
Group A test requirements (method 5005)	1*, 2, 3, 7, 8, 9, 10, and 11
Groups C and D end-point electrical parameters (method 5005)	1, 2, 3 or 2, 8(hot), and 10
Additional electrical subgroups for group C periodic inspections	---

* PDA applies to subgroup 1.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Pin description.

Pin number	Name	I/O	Description
1-8	D7-D0	I/O	Data bus (8-bit)
9, 15, 18	CLK N	I	Counter clock inputs
11, 14, 16	GATE N	I	Counter gate inputs
10, 13, 17	OUT N	O	Counter outputs
22	$\overline{RD}$	I	Read counter
23	$\overline{WR}$	I	Write command or data
21	$\overline{CS}$	I	Chip select
19, 20	A0-A1	I	Counter select
24	V_{CC}		+5 volts
12	GND		Ground

6.4 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

6.5 Approved source of supply. Approved sources of supply are listed herein. Additional sources will be added as they become available. The vendors listed herein have agreed to this drawing and a certificate of compliance (see 3.5 herein) has been submitted to DESC-ECS.

Military drawing part number	Vendor CAGE number	Vendor similar part number 1/	Replacement military specification part number
5962-8752001JX	34335	8253/BJA	
5962-8752002JX	34649	MD8253/B	
5962-8752003JX	34335	8253-5/BJA	

1/ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

Vendor CAGE number	Vendor name and address
34335	Advanced Micro Devices, Inc. 901 Thompson Place P.O. Box 3453 Sunnyvale, CA 94088
34649	Intel Corporation 5000 W Williams Field Road Chandler, AZ 85224